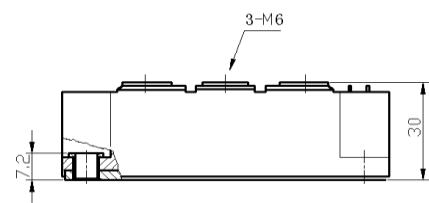
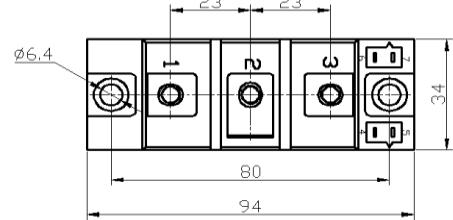
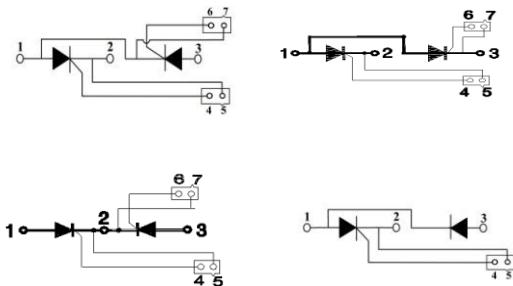


Feature

- International standard package
- Isolation voltage 2500V ~


Application

- Various rectifier power
- AC/DC motor control
- Heater control
- Light dimmer
- Frequency converters



■ Maximum value

Symbol	Parameter	Rating		Unit
		MTC200 -12	MTC200 -16	
V _{RRM}	Repetitive peak reverse voltage	1200	1600	V
V _{RSM}	Non-repetitive peak reverse voltage	1300	1700	V
V _{DRM}	Off-state Repetitive peak voltage	1200	1600	V

Symbol	Item	Conditions	Ratings	Unit
I _{T(AV),I_{F(AV)}}	Thyristor: on-state average current	Single side heat dissipation, 180°sine half wave, 50Hz, T _C :85°C	200	A
	Diode: average forward current	Single side heat dissipation, 180°sine half wave, 50Hz, T _C :100°C		
I _{T(RMS),I_{F(RMS)}}	Thyristor: square root current	Single side heat dissipation, 180°sine half wave, 50Hz, T _C :85°C	314	A
	Diode: forward square root current	Single side heat dissipation, 180°sine half wave, 50Hz, T _C :100°C		
I _{FSM}	Forward surge current	Thyristor: t=10ms, 50Hz,Sin , Tvj=45°C	5800	A
		Diode:t=10ms, 50Hz,Sin , Tvj=45°C	7500	A
I ² t	I ² t value	Thyristor: V _R = 0.6V _{RRM} , Tvj=45°C	168200	A ² S
		Diode:V _R = 0.6V _{RRM} , Tvj=45°C	281250	A ² S
P _{GM}	Peak gate power		10	W
P _{G(AV)}	Average gate power		3	W
di/dt	On-state current critical rise rate	I _{GM} =1.5A, t _r ≤0.5μs, T _j =25°C	150	A/μs
V _{ISO}	Isolation voltage	AC one minute	2500	V
T _j	Operating junction temperature		-40 to +125	°C
T _{jm}	Rated junction temperature	Thyristor:	125	°C
		Diode:	150	°C
T _{stg}	Storage temperature		-40 to +125	°C
Md	Mounting torque(copper plate) M6		5 ± 15%	N·m

	Mounting torque(connection terminal)M6		$5 \pm 15\%$	N·m
W_t	Weight		220	g

■ Electrical characteristics

Symbol	Parameter	Test condition	Rating	Unit
I_{DRM}	Peak off-state repetitive current	$V_D=V_{DRM}$, sine half wave, T_{jm}	30	mA
I_{RRM}	Peak reverse repetitive current	Thyristor: $V_R=V_{RRM}$, sine half wave, T_{jm}	30	mA
		Diode: $V_R=V_{RRM}$, sine half wave, T_{jm}	9	mA
V_{TM}, V_{FM}	Thyristor: on-state peak voltage	$I_{TM}=60A, T_j=25^\circ C$	1.7	V
	Diode: Peak forward voltage	$I_{FM}=600A, T_j=25^\circ C$	1.2	V
V_{GT}	Gate trigger voltage	$T_j=25^\circ C, I_T=1A, V_D=12V$	0.7-1.8	V
I_{GT}	Gate trigger current	$T_j=25^\circ C, I_T=1A, V_D=12V$	20-150	mA
V_{GD}	Gate non-trigger voltage	$T_j=125^\circ C, V_D=2/3V_{DRM}$	0.25	V
I_{GD}	Gate non-trigger current	$T_j=125^\circ C, V_D=2/3V_{DRM}$	10	mA
dv/dt	On-state voltage critical rise rate	$T_j=125^\circ C, V_D=2/3V_{DRM}$	500	V/ μ s
I_H	Holding current	$T_j=25^\circ C$	20-150	mA
I_L	Latching current	$T_j=25^\circ C$	100-400	mA
$R_{th(j-c)}$	Thermal resistance (junction-case)	Thyristor: Single-side heat dissipation, sine half wave	0.19	$^\circ C/W$
		Diode: Single-side heat dissipation, sine half wave	0.21	$^\circ C/W$

Performance Curves

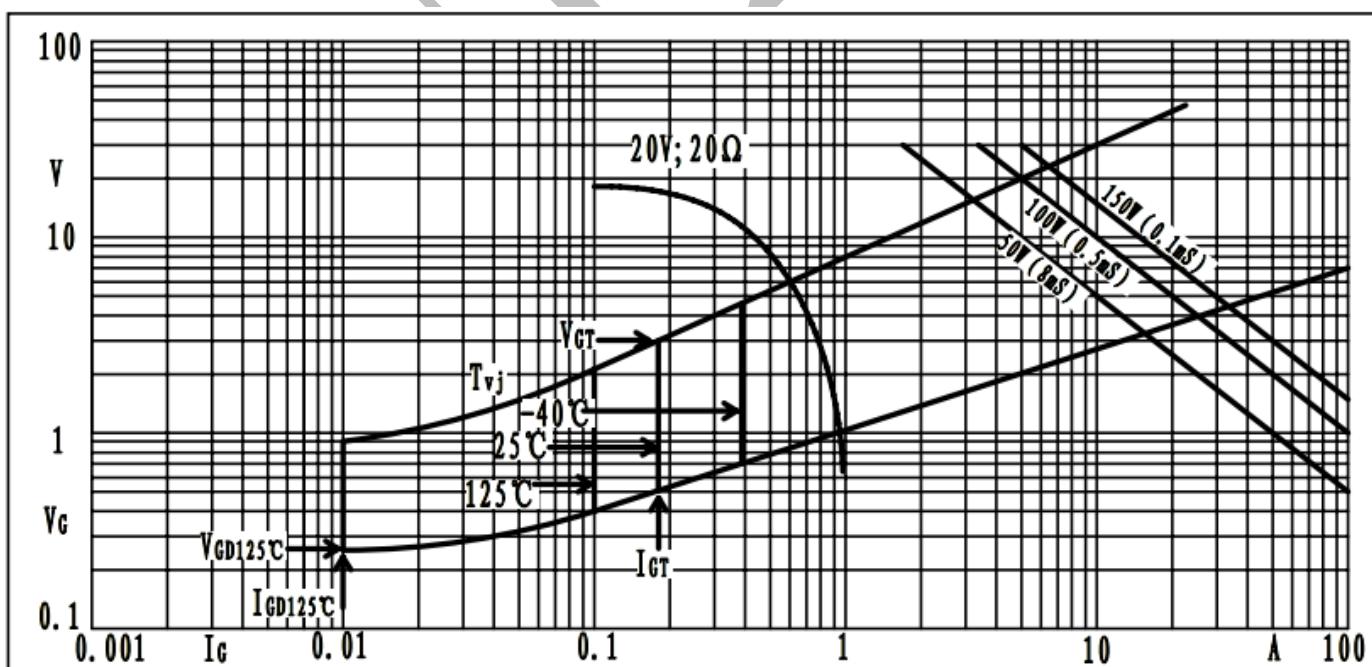


Fig1. Gate trigger characteristics

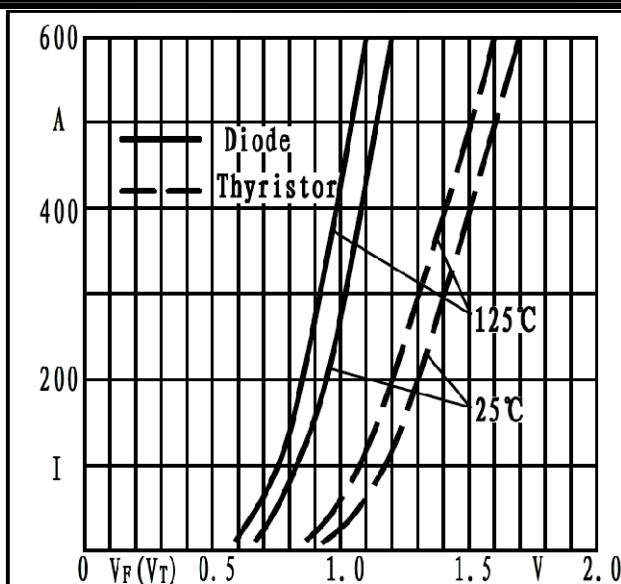


Fig 2. Forward characteristics

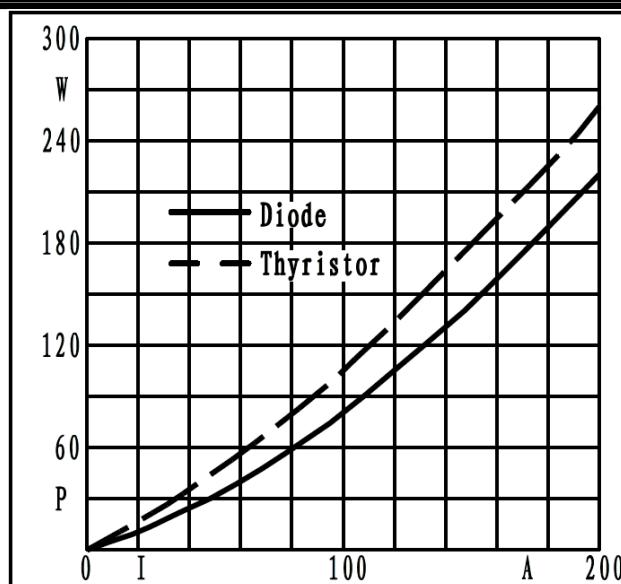


Fig 3. Power dissipation

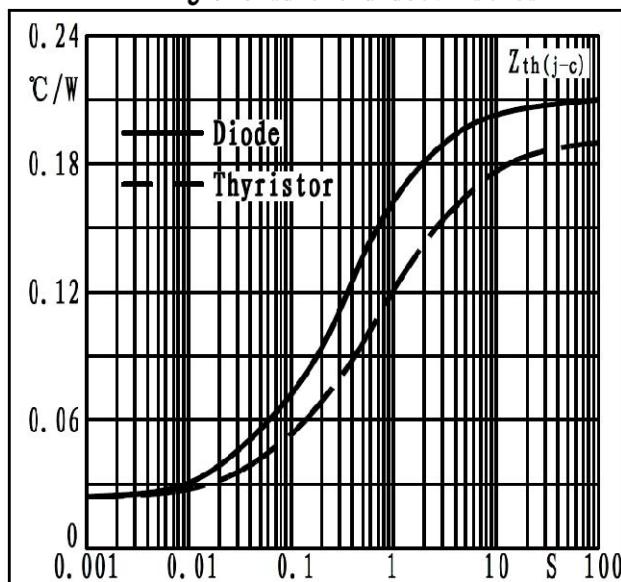


Fig 4. Transient thermal impedance

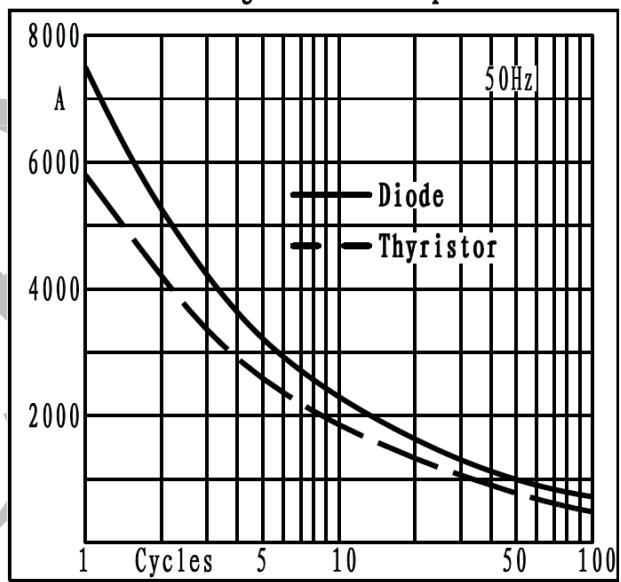


Fig 5. Max non-repetitive forward surge current

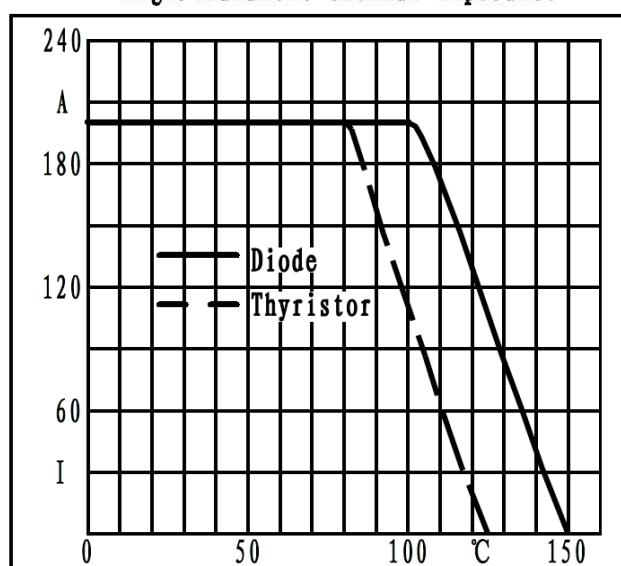


Fig 6. Forward current derating curve